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Best of Conference Papers - 2009

The Electronic Components and Technology Conference is proud to announce the “Best of Conference” papers selected from the 59th ECTC proceedings. The authors of the Best Session Paper share a check for US\$2,500 and the authors of the Best Poster Paper share a check for US\$1,500. The winning authors also receive a personalized plaque commemorating their achievement.

Best Session Paper

(Session 13, paper 2)

Novel Multi-Layer Wiring Buildup using ElectroChemical Pattern Replication (ECPR)
Mikael Fredenberg and Patrik Moller – Replisaurus Technologies and Michael Toepper – Fraunhofer IZM

Best Poster Paper

(Session 38, paper 9)

Demonstration of Board-Level Optical Link with Ceramic Optoelectronic Multi-Chip Module
Krzysztof Nieweglowski, Ralf Rieske and Klaus-Jürgen Wolter - Technische Universität Dresden

Outstanding Papers – 2009

The winning authors for Conference Outstanding Session and Poster Papers receive a personalized plaque commemorating their achievement and will share a check for US\$1,000.

Outstanding Session Paper

(Session 30, paper 1)

Thermomechanical Modeling of Back-End-of-the-Line 3D Interconnects
Jordan Massad, Todd Bauer, and Subhash Shinde – Sandia National Laboratories

Outstanding Poster Paper

(Session 37, paper 20)

Mechanical Characterization of Lead-Free Solder Alloys under High Strain Rate Loads
K. Meier, S. Wiese, M. Roellig, and K. J. Wolter - Technische Universität Dresden

Intel Best Student Paper – 2009

The winning student receives a certificate and a check for \$2,500. The following paper was selected based on the Intel Best Student Paper competition conducted at 59th ECTC in San Diego, California

Ultra Thin Flexible Electronics

Ryan McPherson (student author), Robert Dean, and R. Wayne Johnson – Auburn University, and Linda Del Castillo - JPL

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